

COPY OF PAPERS
ORIGINALLY FILED

2814

DOCKET: CU-2756

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application: In Cheol RYU

Serial No.: 10/034,497

Filed: December 29, 2001

For: METHOD OF FORMING A CONTACT
FOR A SEMICONDUCTOR DEVICE

GRP ART UNIT: 2814

Ex.: QUACH, T.

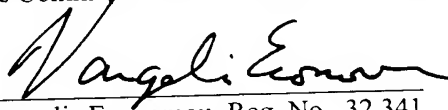
TECHNICAL CENTER 2800

JUL - 8 2002

RECEIVED

Certification under 37 C.F.R. §1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with The United States Postal Service with sufficient postage as first class mail in an envelope addressed to The Commissioner for Patents, Washington, D.C. 20231 on June 24, 2002.


Vangelis Economou, Reg. No. 32,341

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

In response to the Official Action dated March 28, 2002, setting a 3-month shortened statutory period for a reply ending on June 28, 2002, Applicant submits the following responsive amendment in the above-identified application. Applicant believes this amendment places the application in better condition for allowance.